

Docket No.: P2001,0358

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : HOLGER HÜBNER
Filed : CONCURRENTLY HEREWITH
Title : METHOD FOR CONTACT-CONNECTING AN ELECTRICAL
COMPONENT TO A SUBSTRATE HAVING A CONDUCTOR
STRUCTURE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent No. 5,305,944 (Yoshida et al.), dated April 26, 1994;

U.S. Patent No. 6,478,906 B1 (Azdasht et al.), dated November 12, 2002, and corresponding German Published Non-Prosecuted Patent Application DE 195 04 967 A1 (Azdasht et al.), dated August 22, 1996;

U.S. Patent No. 4,972,988 (Ohdate), dated November 27, 1990, and corresponding German Published Non-Prosecuted Patent Application DE 40 23 516 C2 (Ohdate), dated February 7, 1991;

German Published Non-Prosecuted Patent Application DE 37 40 773 A1 (Hieber), dated June 15, 1989, and English abstract thereof;

French Patent Application FR 2 754 619 A1 (Pascal et al.), dated April 17, 1998, and English abstract thereof;

French Patent Application FR 2 780 534 A1 (Stephane), dated December 31, 1999,
and English abstract thereof;

European Patent Application EP 0 907 205 A2 (Koichi et al.), dated April 7, 1999;

European Patent Application EP 0 758 145 A2 (Fujimoto et al.), dated February 12,
1997;

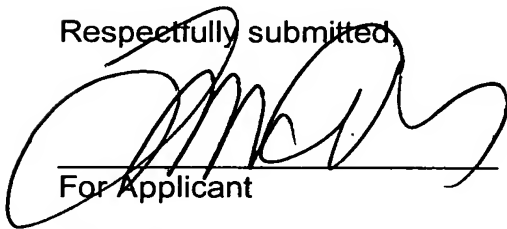
European Patent Application EP 0 694 871 A1 (Audoux et al.), dated January 31,
1996, and English abstract thereof;

Morris, J. W. et al.: "Microstructure and Mechanical Properties of Sn-In and Sn-Bi
Solders", JOM, Minerals Metals and Materials Society, Vol. 45, No. 7, July 1993, pp.
25-27.

International Search Report, dated September 13, 2002.

If no translation of pertinent portions of any foreign language patents or publications
mentioned above is included with the aforementioned copies of those applications,
patents and/or publications, it is because no existing translation is readily available to
the applicant.

Respectfully submitted,



For Applicant

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Date: November 21, 2003

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/nt/kf

FORM PTO-1449 (SUBSTITUTE) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))				Attorney Docket No.: P2001,0358 Appl. No.: <hr/> Applicant: HOLGER HÜBNER <hr/> Filing Date: November 21, 2003 Group Art Unit:			
EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE
	A	5,305,944	4/26/94	Yoshida et al.			
	B	6,478,906 B1	11/12/02	Azdasht et al.			
	C	4,972,988	11/27/90	Ohdate			
	D						
	E						
	F						
	G						
	H						
	I						
FOREIGN PATENT DOCUMENT							
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRANSL. YES NO
	J	195 04 967 A1	8/22/96	Germany			
	K	40 23 516 C2	2/7/91	Germany			
	L	37 40 773 A1	6/15/89	Germany			
	M	2 754 619 A1	4/17/98	France			
	N	2 780 534 A1	12/31/99	France			
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)							
EXAMINER				DATE CONSIDERED			
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

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	A						
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FOREIGN PATENT DOCUMENT							
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRANSL. YES NO
	J	0 907 205 A2	4/7/99	Europe			
	K	0 758 145 A2	2/12/97	Europe			
	L	0 694 871 A1	1/31/96	Europe			
	M						
	N						
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		Morris, J. W. et al.: "Microstructure and Mechanical Properties of Sn-In and Sn-Bi Solders", JOM, Minerals Metals and Materials Society, Vol. 45, No. 7, July 1993, pp. 25-27					
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